



Assembly Notes:

Built on TPS61161 EVM-243 Rev_F

Connect J3 with J6, short JP1

Do not populate J5, JP2, D2...D11, C4, R3



Title		
5Vin...12Vin to 30V@10mA Boost converter		
Size	Number	Rev
B	PMP8521	A
Date	12/6/2012	Drawn by R. Scibilia
Filename	PMP8521 Rev_A_PADS_pads.sch	Sheet 1 of 1

Engineer R. Scibilia

12/6/2012

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